

### **FEATURES**

Surface Mounting Design 3.2\*2.5\*2.5mm

High Current Handling Capability 1000A @ 8/20 µs

Low Capacitance and Insertion Loss

Quick Response and Long Service Life

Moisture sensitivity level: Level 1





## **APPLICATION INFORMATION**

Communication equipment.
Repeaters, Modems
Telephone Interface,Line cards.
Data communication equipment.

## **AGENCY APPROVALS**

lcon	Solderability	
RoHS	Compliance with 2011/65/EU	
HF	Compliance with IEC61249-2-21:2003	
<b>%</b>	Mean lead free	

# **PRODUCT CHARACTERISTICS**

Lead Material	Body Material	Terminal Finish
Copper or Fe-Ni alloy	Ceramics	100% Matte-Tin Plated



# **ELECTRICAL PARAMETER**

Parameter	Condition Rating		Unit
DC Blocking Voltage 1)	100V/s	100V/s 376-564	
Impulse Spark-over Voltage	At 1kV/μs	for 99 % of measured values ≤1000	V
impuise Spark-over voltage	At 1kV/μs	Typical values of distribution ≤950	V
Impulse Discharge Current 2)	8/20µs	1000	
Insulation Resistance	DC=100V	≥ 1	GΩ
Capacitance at 1MHz	MHz $V_{DC}=0.5V$ $\leq 0.5$		рF
Operating And Storage Temperature		-40-125	°C

<sup>1)</sup> In ionized mode

# **ENVIRONMENTAL RELIABILITY CHARACTERISTICS**

Testing items	Technical standards	
High Temperature Storage Test	Temperature: 85°C ; Time:2H	
Low Temperature Storage Test	Temperature: -40°C ; Time:2H	
Vibration	Frequency: 10-500Hz ; Amplitude: 0.15mm ; Time:45min	
Resistance of soldering heat	Temperature:260°C;Time of dip soldering :10s,1time	

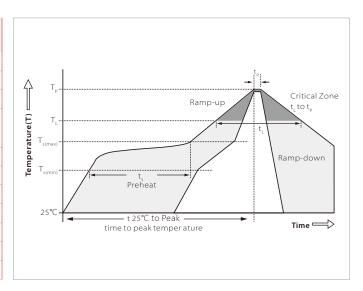
**NOTE:** Up-screen program can be specified by customer's request via contacting Semiware service

<sup>2)</sup> Terms and waveforms in accordance with ITU-T Rec. K. 12; IEC 61643-21  $\,$ 

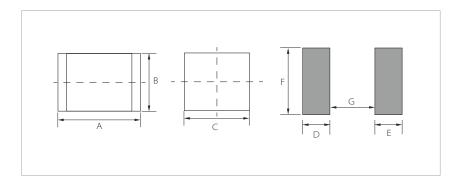


## **REFLOW PROFILE**

Reflow Condition		Lead-free assembly	
	Temperature Min	150°C	
Pre Heat	Temperature Max	200°C	
	Time(min to max)	60~180 secs	
Average ra	amp up rate (Liquidus)Temp $(T_L)$ to peak	3°C/second max	
	$T_s(max)to T_L$ - Ramp-up Rate	3 C/second max	
Doflow	Temperature (T <sub>L</sub> ) (Liquidus)	217°C	
Reflow	Time (min to max) $(t_s)$	60 – 150 seconds	
Peak Tem	perature (Tp)	260+0/-5°C	
Time within 5°C of actual peak Temperature (tp)		10- 30 seconds	
Ramp-down Rate		6°C/second max	
Time 25°C to peak Temperature (T₂)		8 minutes max.	
Do not exceed		260°C	



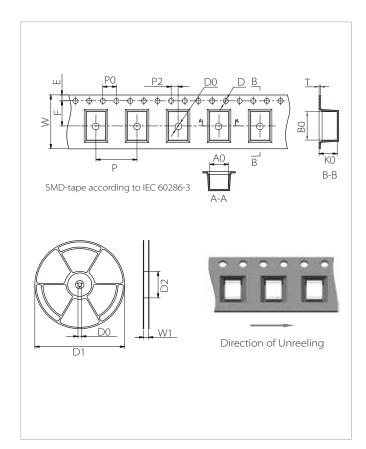
# PRODUCT DIMENSIONS AND RECOMMENDED SOLDERING PAD



Ref.	mm	
А	3.2±0.2mm	
В	2.5±0.2mm	
С	2.5±0.2mm	
D	1.2mm	
Е	1.2mm	
F	3mm	
G	1.5mm	



## **TAPE AND REEL SPECIFICATION**



Ref.	Dimensions		
Rei.	Millimeters	Inches	
W	12±0.3	0.472±0.012	
A0	2.8±0.1	0.110±0.004	
ВО	3.5±0.1	0.138±0.004	
KO	2.8±0.1	0.110±0.004	
Р	8.0±0.1	0.315±0.004	
F	5.5±0.1	0.217±0.004	
E	1.75±0.1	0.069±0.004	
D	1.5+0.1/-0.0	0.059+0.004/-0.0	
P0	4±0.1	0.157±0.004	
P2	2±0.1	0.079±0.004	
Т	0.35±0.05	0.014±0.002	
D0	13.3±0.15	0.524±0.006	
D1	330±2	12.992±0.079	
D2	100+1/-2	3.937+0.039/-0.079	
W1	12.5±0.4	0.492±0.016	

# **ORDERING INFORMATION**

Part Number	Size	QTY/Reel	Reel Size
SG3225B470	3.2*2.5*2.5mm	2500PCS	13"



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### By QR Code





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Machat

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